RICOH RP103x SERIES

LOW NOISE 150mA LDO REGULATOR

NO.EA-149-070720

OUTLINE

The RP103x Series are CMOS-based voltage regulator ICs with high output voltage accuracy, extremely low supply current, low ON-resistance, and high ripple rejection. Each of these ICs consists of a voltage reference unit, an error amplifier, resistor-net for voltage setting, a current limit circuit, and a chip enable circuit.

These ICs perform with low dropout voltage and a chip enable function. The line transient response and load transient response of the RP103x Series are excellent, thus these ICs are very suitable for the power supply for hand-held communication equipment.

The output voltage of these ICs is fixed with high accuracy. Since the packages for these ICs are PLP1010-4, SOT23-5, SC82-AB, therefore high density mounting of the ICs on boards is possible.

FEATURES

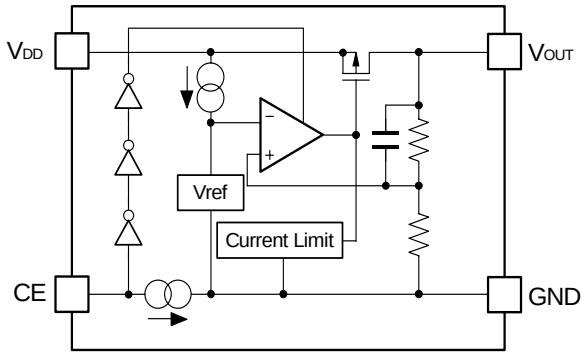
- Supply Current .....Typ. 36μA
- Standby Mode .....Typ. 0.1μA
- Dropout Voltage.....Typ. 0.21V (I_{OUT}=150mA, V_{OUT}=2.8V)
- Ripple Rejection .....Typ. 75dB (f=1kHz)
- Temperature-Drift Coefficient of Output Voltage .....Typ. ±30ppm/°C
- Line Regulation .....Typ. 0.02%/V
- Output Voltage Accuracy.....±1.0%
- Packages.....PLP1010-4, SOT-23-5, SC-82AB
- Input Voltage Range.....1.7V to 5.25V
- Output Voltage.....1.2V, 1.3V, 1.5V, 1.8V, 1.85V, 1.9V, 2.0V, 2.3V, 2.5V
  2.6V, 2.7V, 2.8V, 2.85V, 2.9V, 3.0V, 3.1V, 3.3V
- Built-in Fold Back Protection Circuit.....Typ. 40mA (Current at short mode)
- Ceramic capacitors are recommended to be used with this IC .... 0.47μF or more

APPLICATIONS

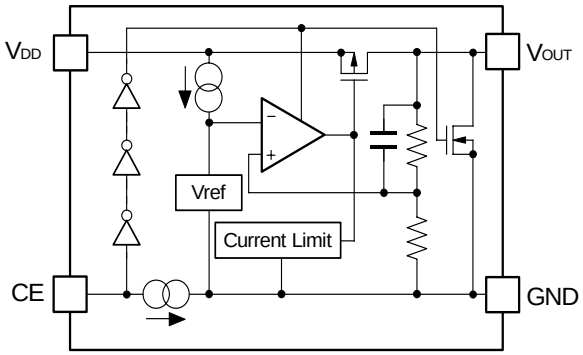
- Power source for portable communication equipment.
- Power source for electrical appliances such as cameras, VCRs and camcorders.
- Power source for battery-powered equipment.
- Power source for home appliances.

BLOCK DIAGRAMS

RP103xxx1B



RP103xxx1D



SELECTION GUIDE

The output voltage, auto discharge function*, and the taping type for the ICs can be selected at the user's request.

The selection can be made with designating the part number as shown below;

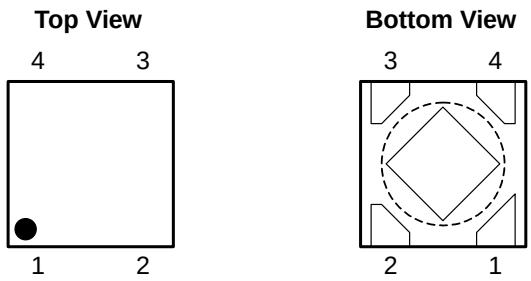
RP103xxx1x-xx-x ←Part Number
↑ ↑ ↑ ↑ ↑
a b c d e

Code	Contents
a	Designation of Package Type: K: PLP1010-4 N: SOT-23-5 Q: SC-82AB
b	Setting Output Voltage (V_{OUT}): The following 16 kinds of voltage are standard. 1.2V, 1.3V, 1.5V, 1.8V, 1.85V, 1.9V, 2.0V, 2.3V, 2.5V, 2.6V, 2.7V, 2.8V, 2.85V, 2.9V, 3.0V, 3.1V, 3.3V Exceptions:1.85V=RP103x181x5-xx-x, 2.85V=RP103x281x5-xx-x
c	Designation of Mask Option B: active high, without auto discharge function* at OFF state. D: active high, with auto discharge function* at OFF state.
d	Designation of Taping Type: Ex. TR (refer to Taping Specifications; TR type is the standard direction.)
e	Designation of composition of pin plating: -F: Lead free plating (SOT-23-5, SC-82AB) None: Au plating (PLP1010-4)

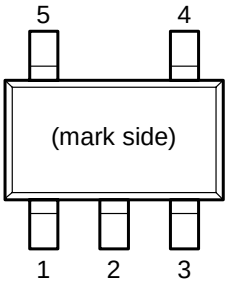
*) When the mode is into standby with CE signal, auto discharge transistor turns on, and it makes the turn-off speed faster than normal type.

PIN CONFIGURATIONS

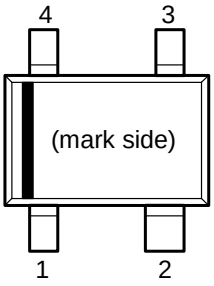
● **PLP1010-4**



● **SOT-23-5**



● **SC-82AB**



PIN DESCRIPTIONS

● **PLP1010-4**

Pin No.	Symbol	Description
1	V_{OUT}	Output Pin
2	GND	Ground Pin
3	CE	Chip Enable Pin ("H" Active)
4	V_{DD}	Input Pin

∗) Tab in the ◌ parts have GND level.
(They are connected to the back side of this IC.)
Do not connect to other wires or land patterns.

● **SOT-23-5**

Pin No.	Symbol	Description
1	V_{DD}	Input Pin
2	GND	Ground Pin
3	CE	Chip Enable Pin ("H" Active)
4	NC	No Connection
5	V_{OUT}	Output Pin

● **SC-82AB**

Pin No.	Symbol	Description
1	CE	Chip Enable Pin ("H" Active)
2	GND	Ground Pin
3	V_{OUT}	Output Pin
4	V_{DD}	Input Pin

ABSOLUTE MAXIMUM RATINGS

Symbol	Item	Rating	Unit
V_{IN}	Input Voltage	6.0	V
V_{CE}	Input Voltage (CE Pin)	6.0	V
V_{OUT}	Output Voltage	–0.3 to V_{IN}+0.3	V
I_{OUT}	Output Current	180	mA
P_D	Power Dissipation* (PLP1010-4)	400	mW
	Power Dissipation* (SOT-23-5)	420	
	Power Dissipation* (SC-82AB)	380	
Topt	Operating Temperature Range	–40 to 85	°C
Tstg	Storage Temperature Range	–55 to 125	°C

*) For Power Dissipation, please refer to PACKAGE INFORMATION to be described.

ELECTRICAL CHARACTERISTICS

- **RP103xxx1B/D**

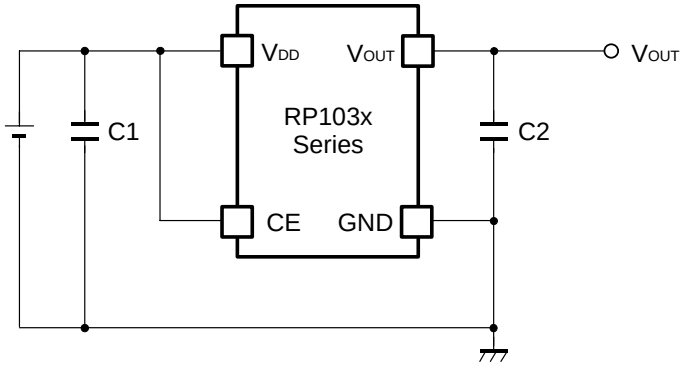
V_{IN}=Set V_{OUT}+1V for V_{OUT} options greater than 1.5V. V_{IN}=2.5V for $V_{OUT} \leqq$ 1.5V.
I_{OUT}=1mA, C_{IN}=C_{OUT}=0.47µF, unless otherwise noted.
☐ **values indicate -40°C ≦ Ta ≦ 85°C, unless otherwise noted.**

Topt=25°C

Symbol	Item	Conditions		Min.	Typ.	Max.	Unit
V_{OUT}	Output Voltage	Topt=25°C	V_{OUT} > 2.0V	×0.99		×1.01	V
			$V_{OUT} \leqq$ 2.0V	−20		+20	mV
		-40°C ≦ Topt ≦ 85°C	V_{OUT} > 2.0V	×0.985		×1.015	V
			$V_{OUT} \leqq$ 2.0V	−30		+30	mV
I_{OUT}	Output Current			150			mA
$\Delta V_{OUT}/\Delta I_{OUT}$	Load Regulation	1mA ≦ I_{OUT} ≦ 150mA			10	30	mV
V_{DIF}	Dropout Voltage	I_{OUT}=150mA	1.2V ≦ V_{OUT} < 1.5V		0.50	0.62	V
			1.5V ≦ V_{OUT} < 1.7V		0.38	0.47	
			1.7V ≦ V_{OUT} < 2.0V		0.34	0.42	
			2.0V ≦ V_{OUT} < 2.5V		0.28	0.36	
			2.5V ≦ V_{OUT} < 2.8V		0.22	0.30	
			2.8V ≦ $V_{OUT} \leqq$ 3.3V		0.21	0.27	
I_{SS}	Supply Current	I_{OUT}=0mA			36	50	µA
$I_{standby}$	Supply Current (Standby)	V_{CE}=0V			0.1	1.0	µA
$\Delta V_{OUT}/\Delta V_{IN}$	Line Regulation	Set V_{OUT}+0.5V ≦ V_{IN} ≦ 5.0V			0.02	0.10	%/V
RR	Ripple Rejection	f=1kHz, Ripple 0.2Vp-p V_{IN}=Set V_{OUT}+1V, I_{OUT}=30mA (In case that $V_{OUT} \leqq$ 2.0V, V_{IN}=3.0V)			75		dB
V_{IN}	Input Voltage*			1.7		5.25	V
$\Delta V_{OUT}/\Delta Topt$	Output Voltage Temperature Coefficient	−40°C ≦ Topt ≦ 85°C			±30		ppm /°C
I_{lim}	Short Current Limit	V_{OUT}=0V			40		mA
I_{PD}	CE Pull-down Current				0.3		µA
V_{CEH}	CE Input Voltage "H"			1.5			V
V_{CEL}	CE Input Voltage "L"					0.3	V
en	Output Noise	BW=10Hz to 100kHz I_{OUT}=30mA			60		µVrms
R_{LOW}	Low Output Nch Tr. ON Resistance (of D version)	V_{IN}=4.0V V_{CE}=0V			30		Ω

*) When Input Voltage is 5.5V, the total operational time must be within 500hrs.

TYPICAL APPLICATION



(External Components)
C2 0.47μF MURATA: GRM155B30J474KE18B

TECHNICAL NOTES

When using these ICs, consider the following points:

Phase Compensation

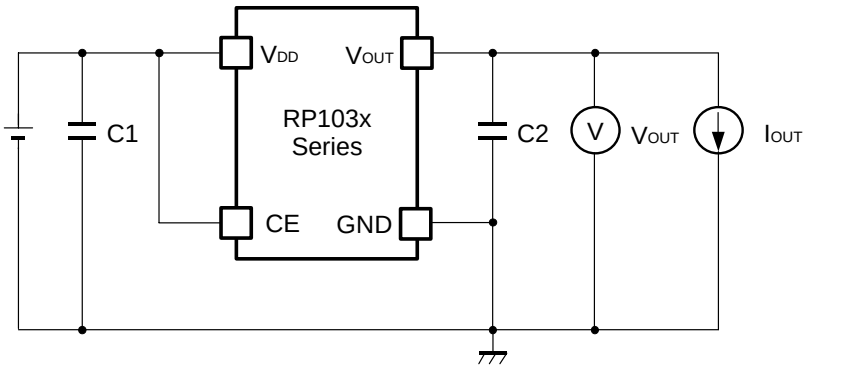
In these ICs, phase compensation is made for securing stable operation even if the load current is varied. For this purpose, use a capacitor C2 with good frequency characteristics and ESR (Equivalent Series Resistance). (Note: If additional ceramic capacitors are connected with parallel to the output pin with an output capacitor for phase compensation, the operation might be unstable. Because of this, test these ICs with as same external components as ones to be used on the PCB.)

PCB Layout

Make V_{DD} and GND lines sufficient. If their impedance is high, noise pickup or unstable operation may result. Connect a capacitor C1 with a capacitance value as much as 0.47μF or more between V_{DD} and GND pin, and as close as possible to the pins.

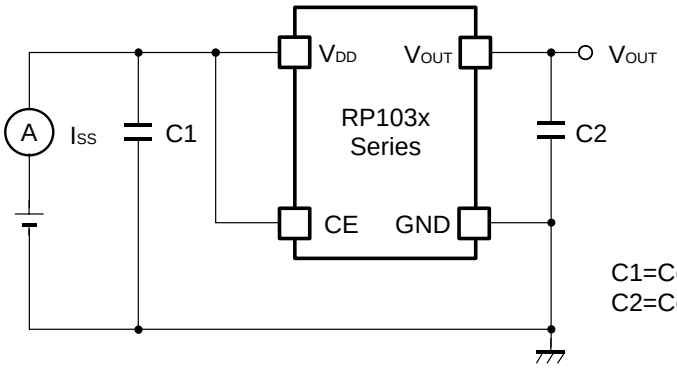
Set external components, especially the output capacitor C2, as close as possible to the ICs, and make wiring as short as possible.

TEST CIRCUITS



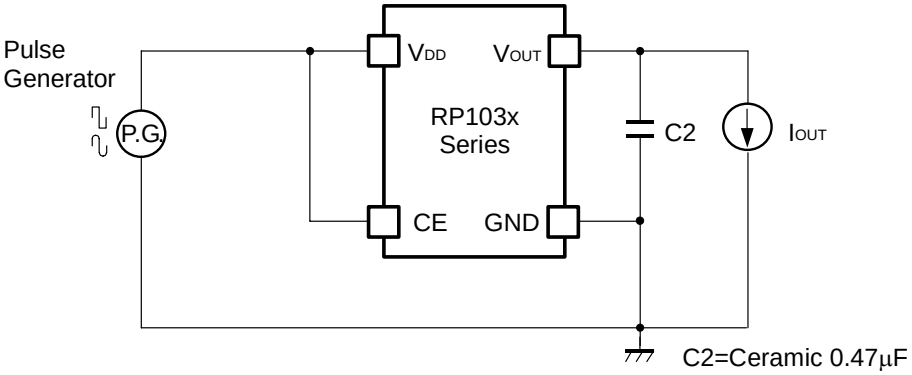
C1=Ceramic 0.47µF
C2=Ceramic 0.47µF

Basic Test Circuit



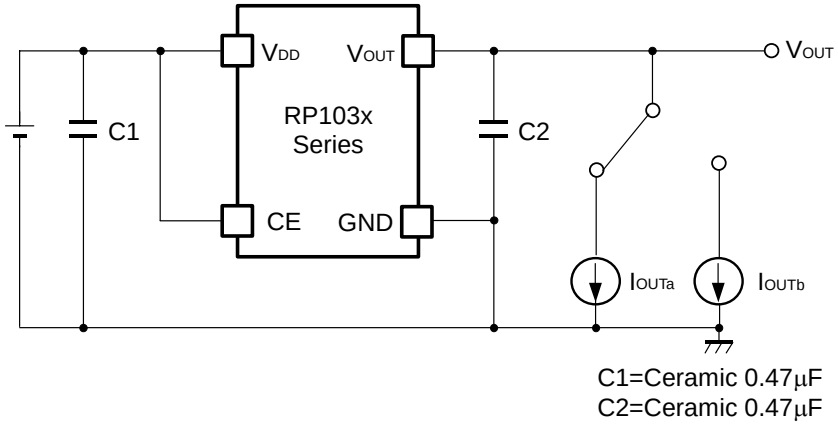
C1=Ceramic 0.47µF
C2=Ceramic 0.47µF

Test Circuit for Supply Current



C2=Ceramic 0.47µF

Test Circuit for Ripple Rejection

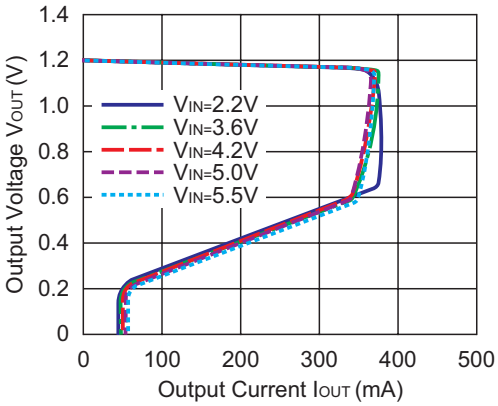


Test Circuit for Load Transient Response

TYPICAL CHARACTERISTICS

1) Output Voltage vs. Output Current (C1=0.47µF, C2=0.47µF, Topt=25°C)

RP103x121x



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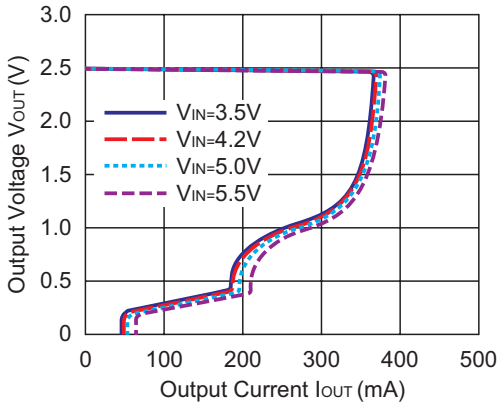

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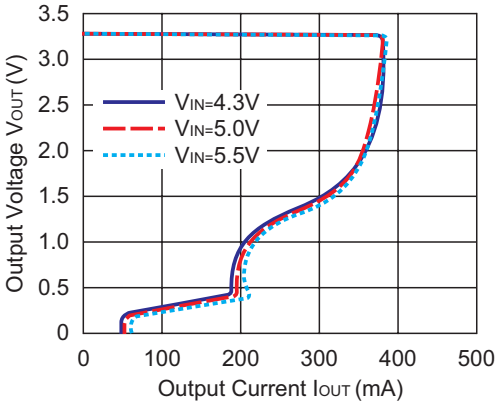
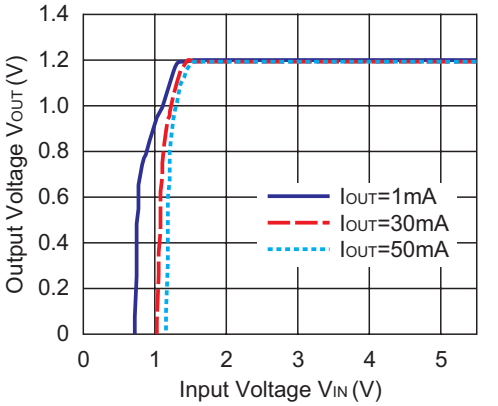


2) Output Voltage vs. Input Voltage (C1=0.47µF, C2=0.47µF, Topt=25°C)

RP103x121x



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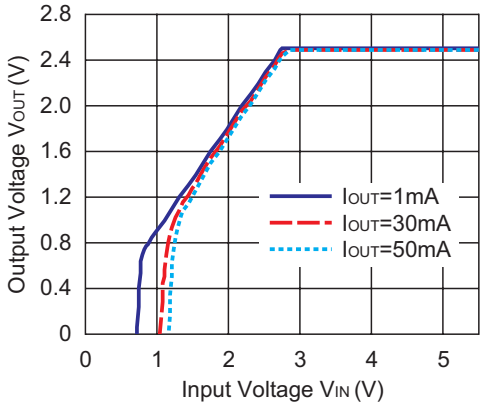

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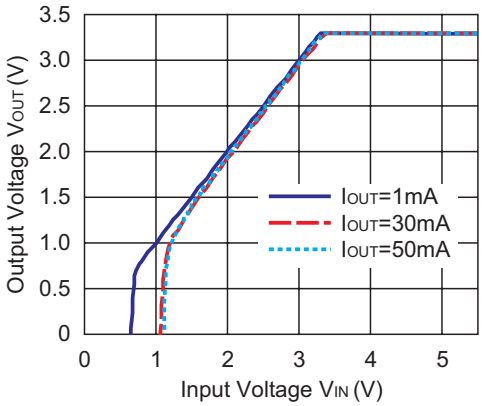
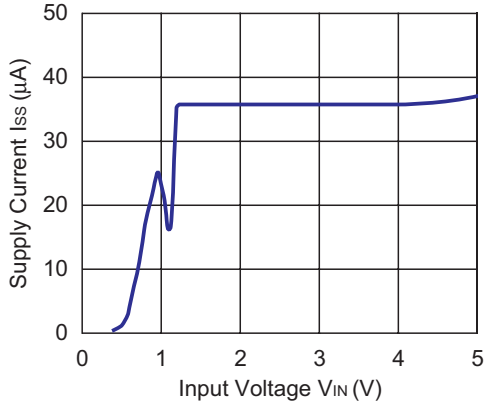


3) Supply Current vs. Input Voltage (C1=0.47μF, C2=0.47μF, Topt=25°C)

RP103x121x



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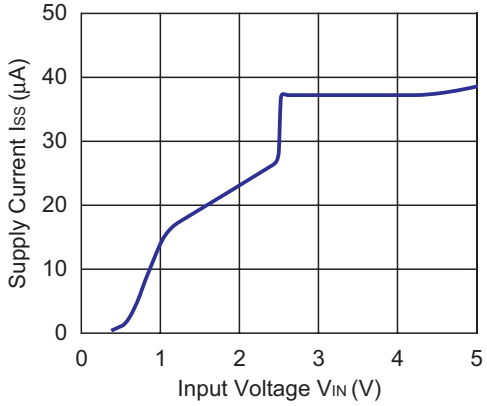

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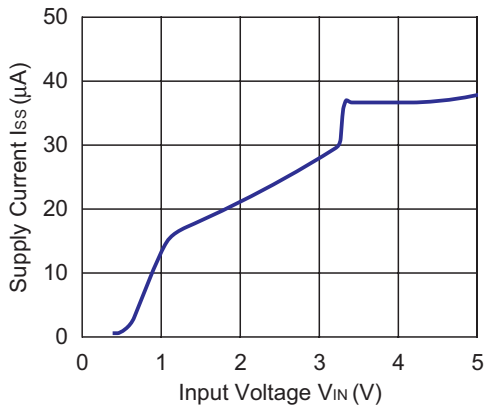
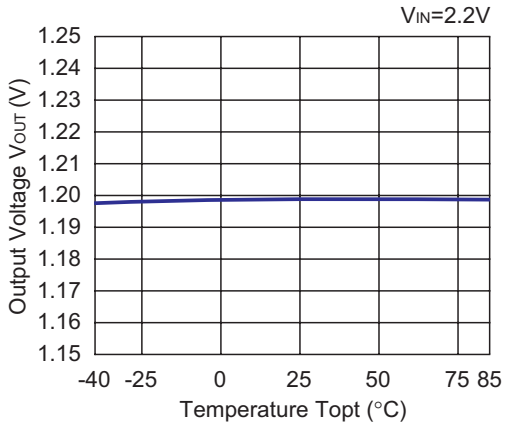


4) Output Voltage vs. Temperature (C1=0.47µF, C2=0.47µF, I_{OUT}=1mA)

RP103x121x



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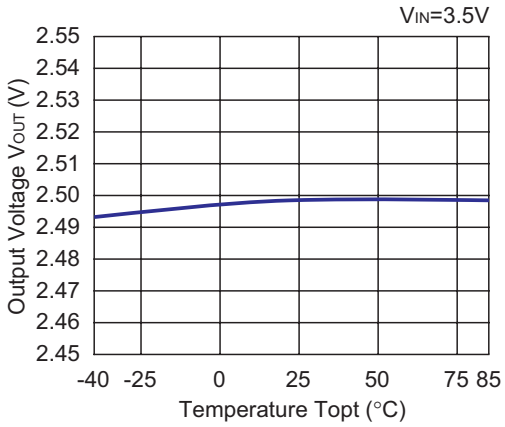

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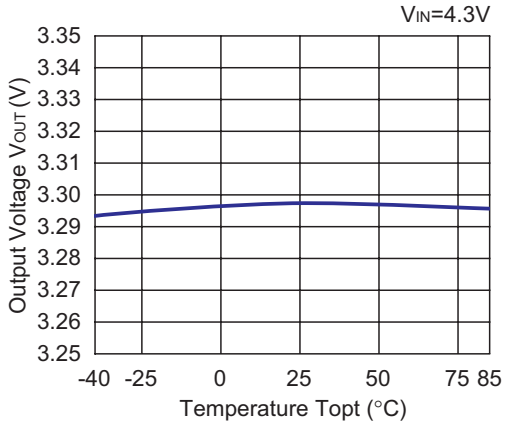
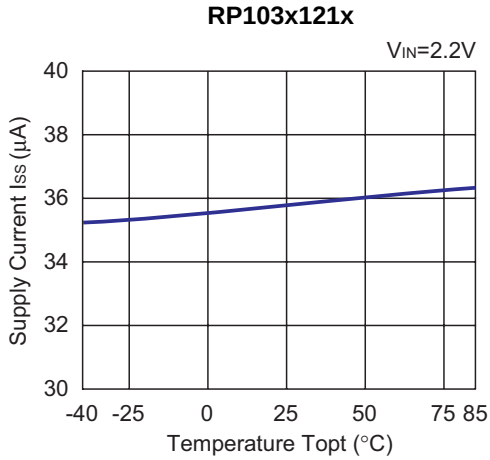


5) Supply Current vs. Temperature (C1=0.47µF, C2=0.47µF, I_{OUT}=0mA)

RP103x121x



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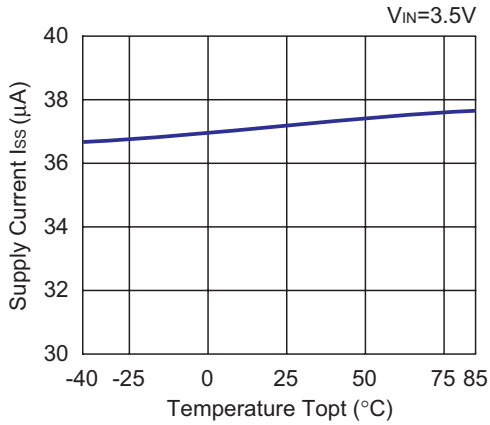

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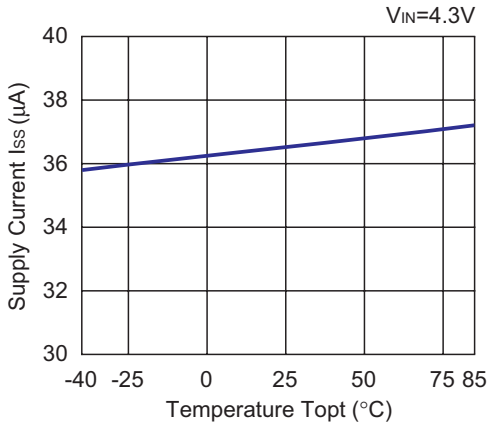
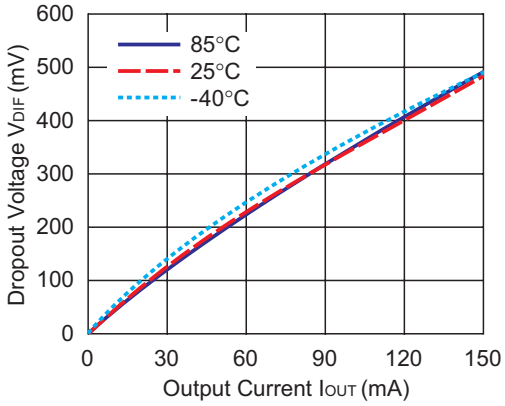


6) Dropout Voltage vs. Output Current (C1=0.47µF,C2=0.47µF)

RP103x121x



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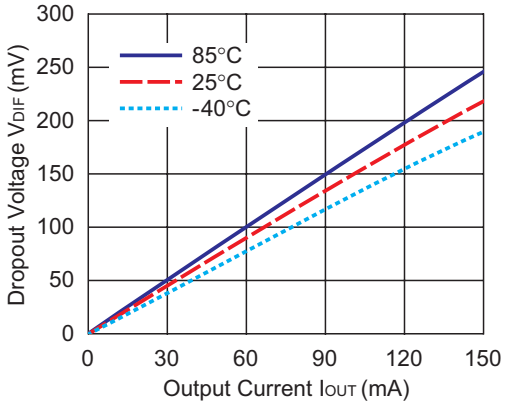

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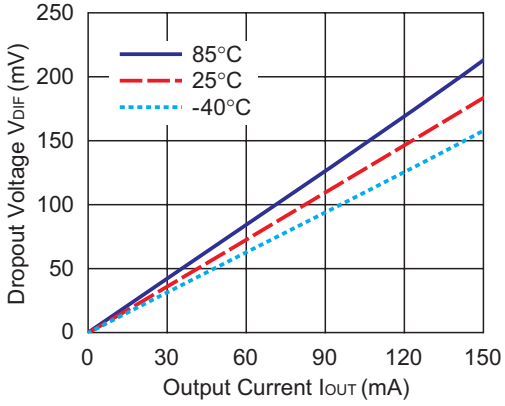
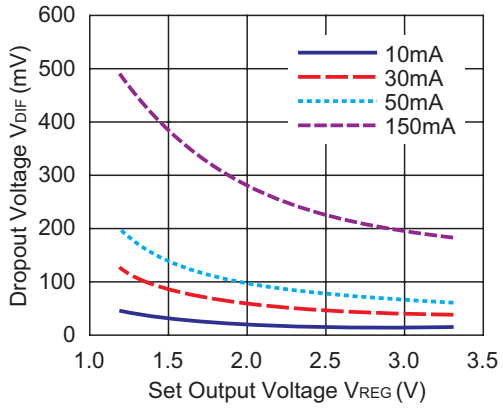
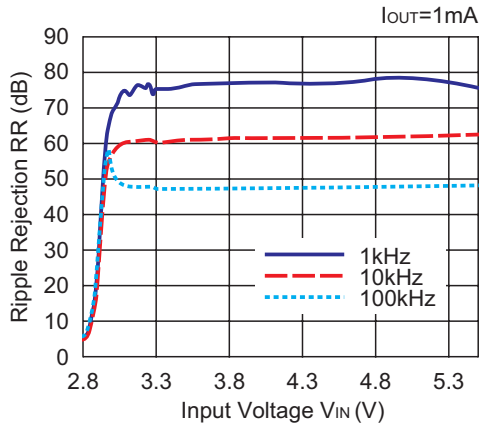


7) Dropout Voltage vs. Set Output Voltage (C1=0.47µF, C2=0.47µF, Topt=25°C)



8) Ripple Rejection vs. Input Bias Voltage (C1=0.47µF, C2=0.47µF, Ripple=0.2VP-P, Topt=25°C)

RP103x281x



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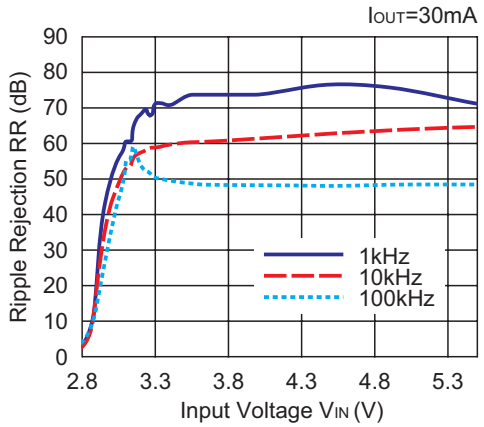
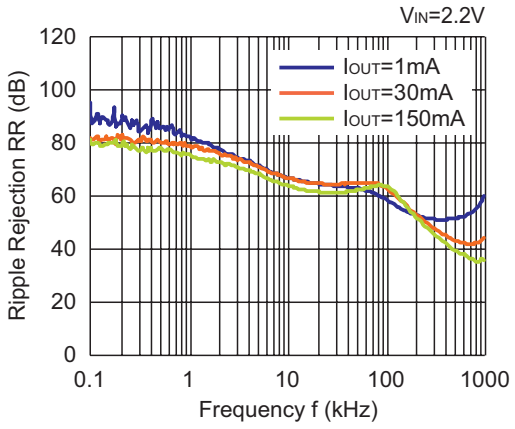


9) Ripple Rejection vs. Frequency (C1=none, C2=0.47µF, Ripple=0.2VP-P)

RP103x121x



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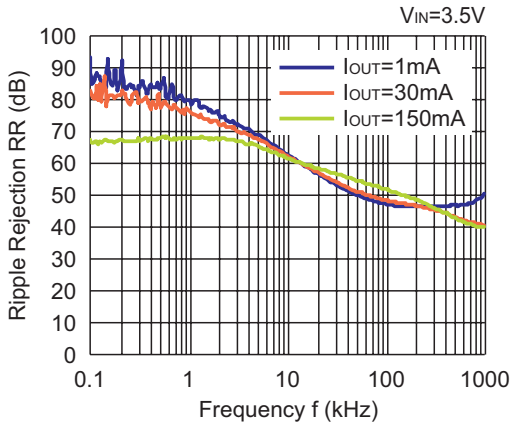

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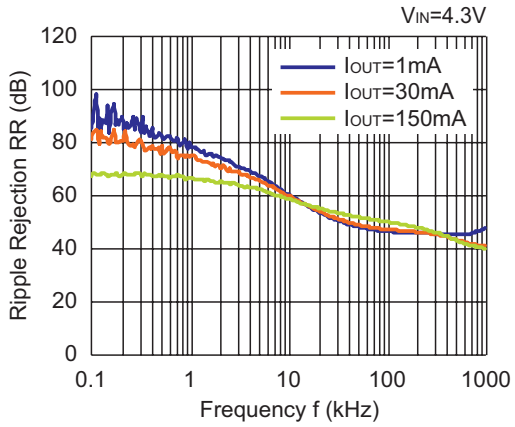
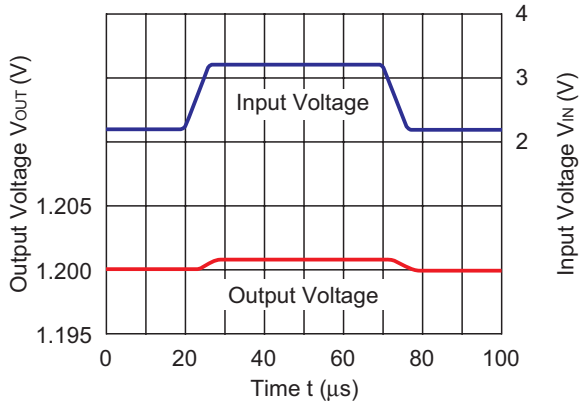


10) Input Transient Response (IOUT=30mA, tr=tf=5µs, Topt=25°C)

RP103x121x



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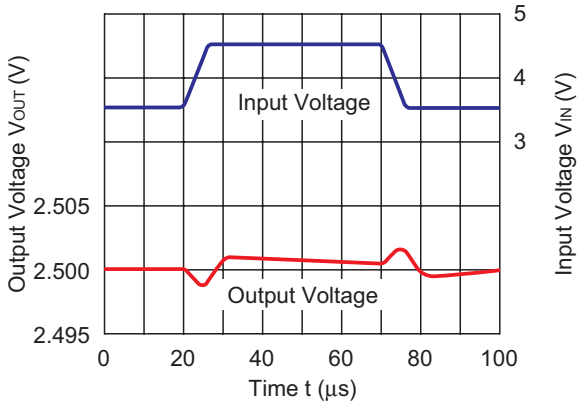

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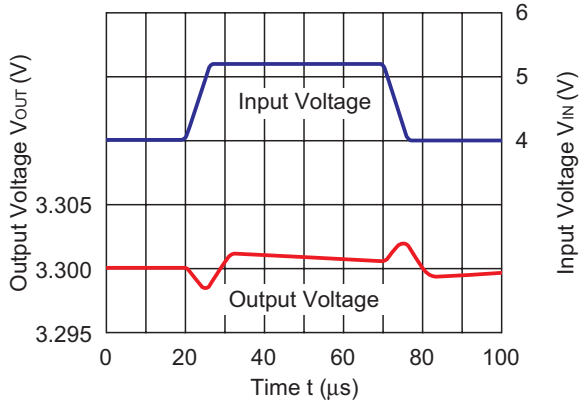
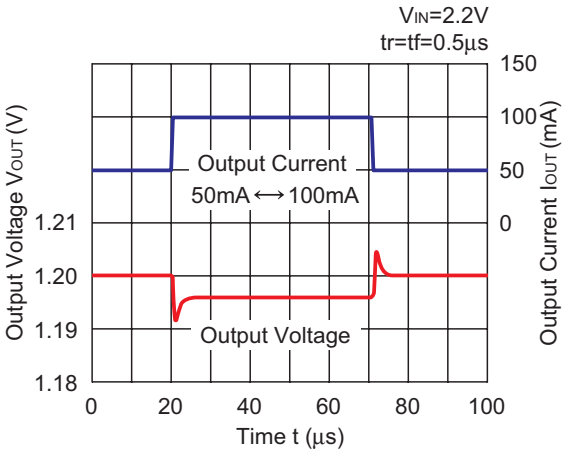
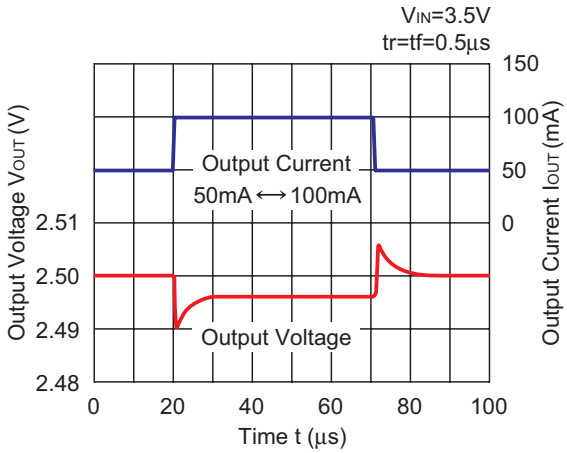


11) Load Transient Response (C1=0.47µF, C2=0.47µF, Topt=25°C)

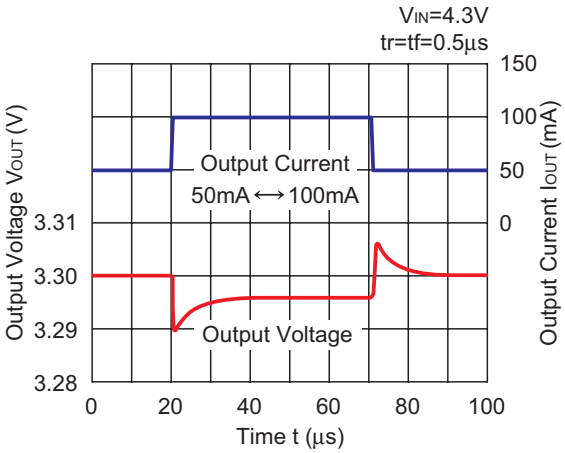
RP103x121x



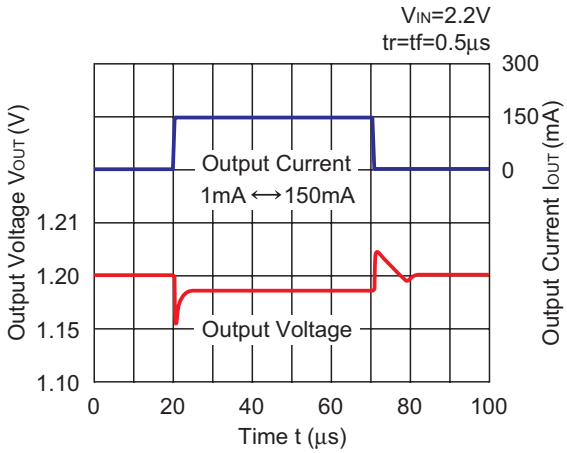
RP103x251x



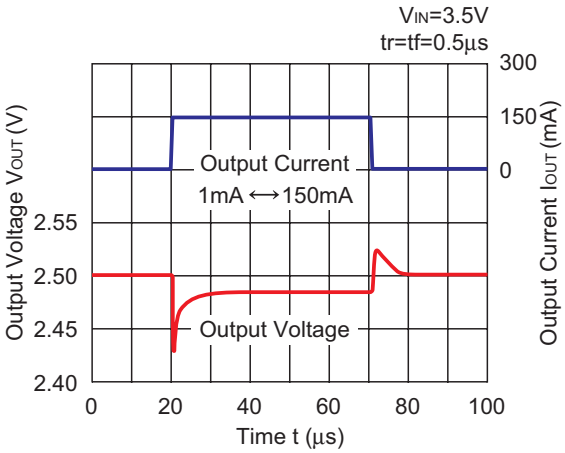
RP103x331x



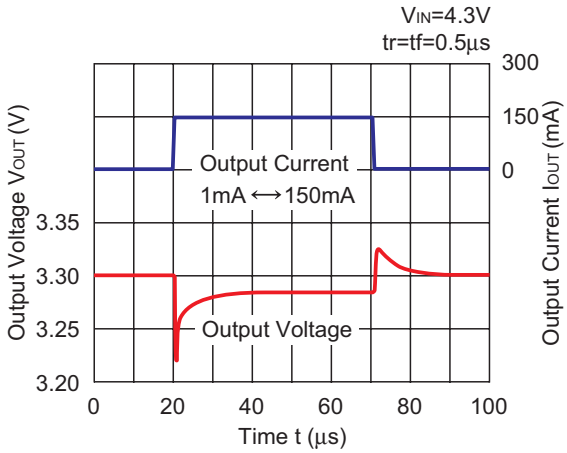
RP103x121x



RP103x251x

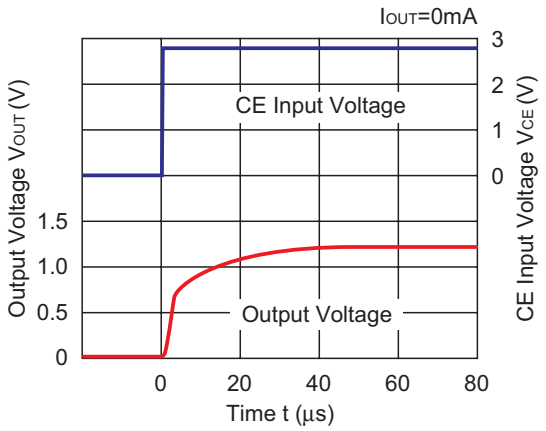


RP103x331x

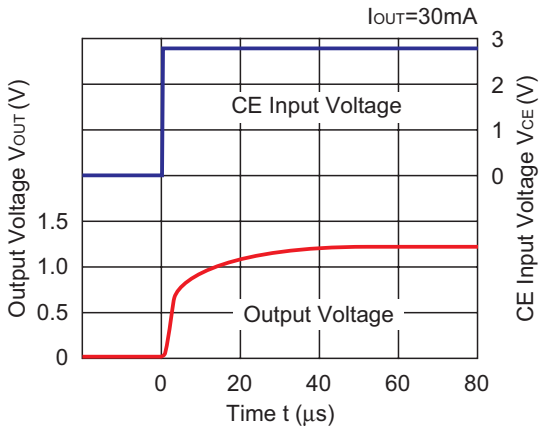


12) Turn On Speed with CE pin (C1=0.47µF, C2=0.47µF, Topt=25°C)

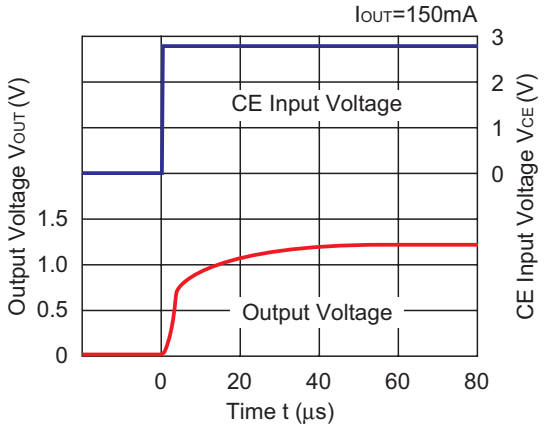
RP103x121x



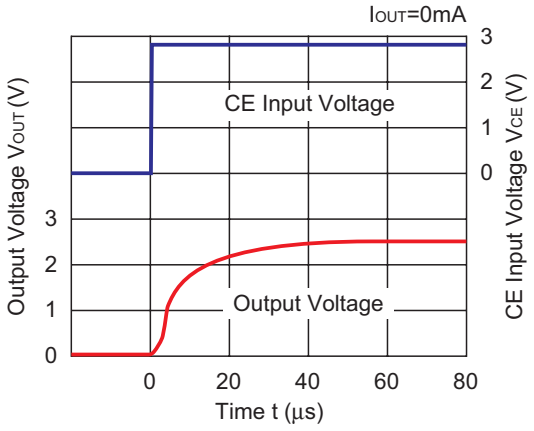
RP103x121x



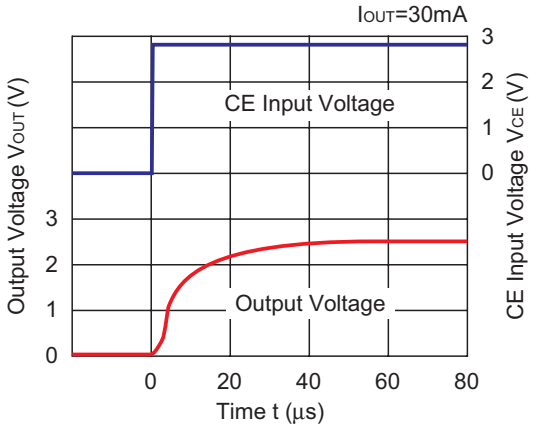
RP103x121x



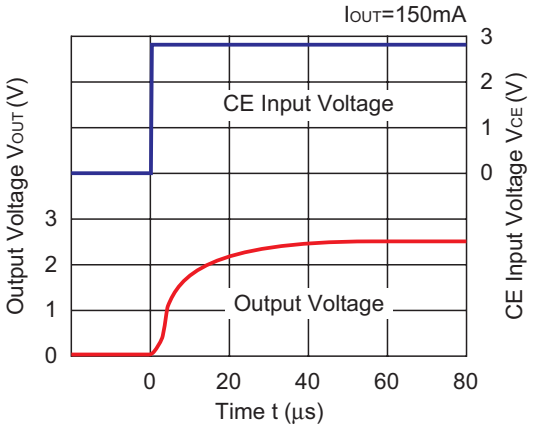
RP103x251x



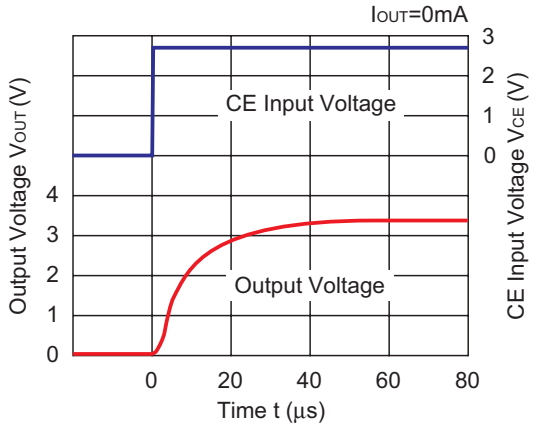
RP103x251x



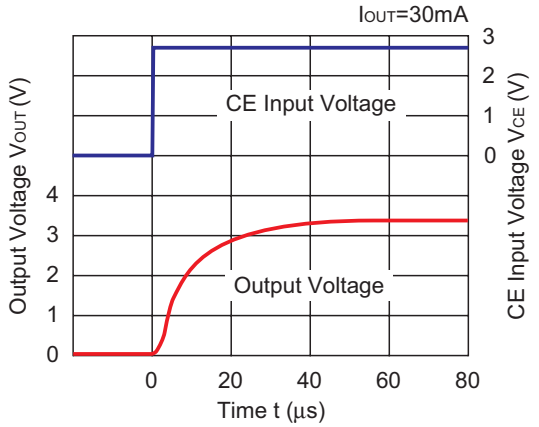
RP103x251x



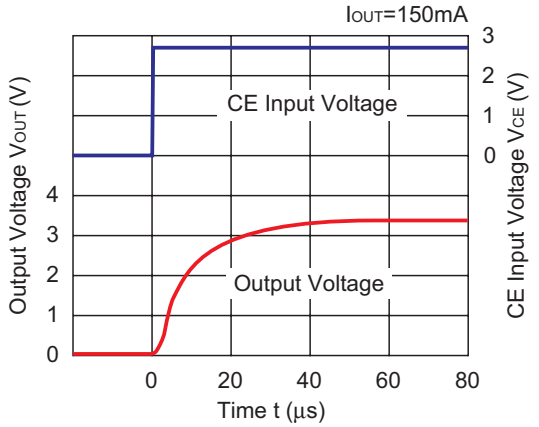
RP103x331x



RP103x331x

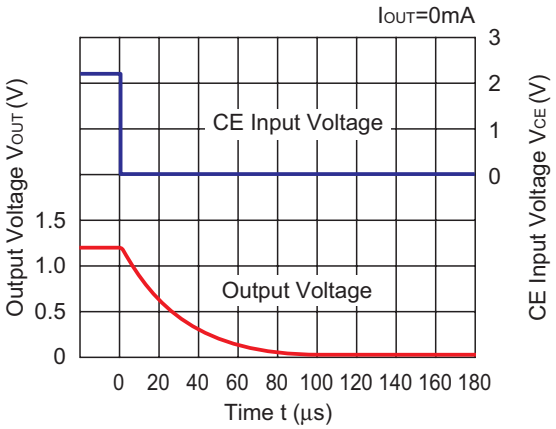


RP103x331x

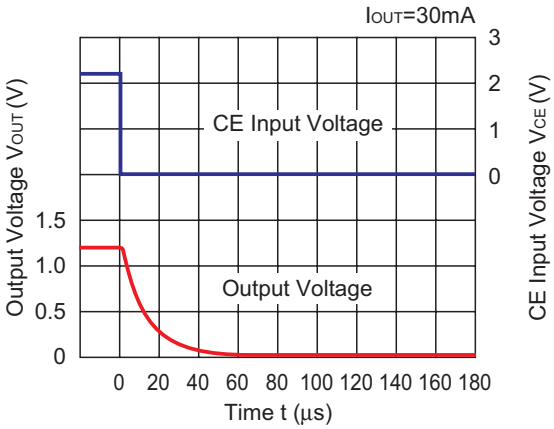


13) Turn Off Speed with CE pin (D Version) (C1=0.47µF, C2=0.47µF, Topt=25°C)

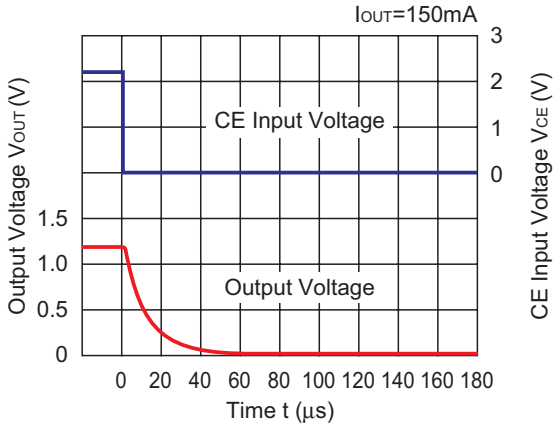
RP103x121D



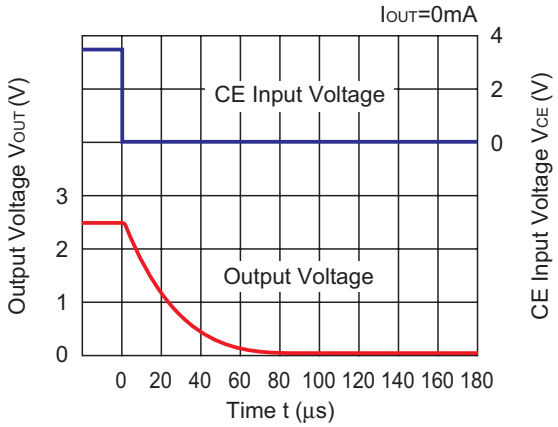
RP103x121D



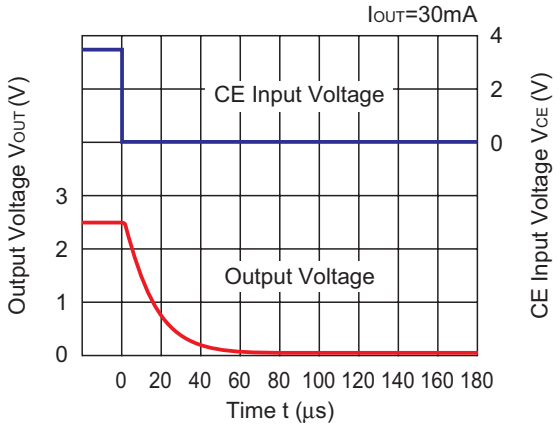
RP103x121D



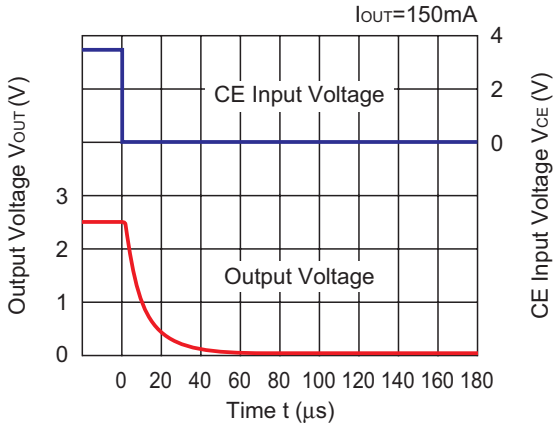
RP103x251D



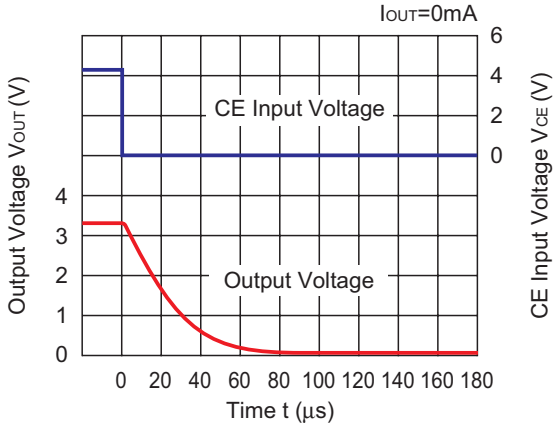
RP103x251D



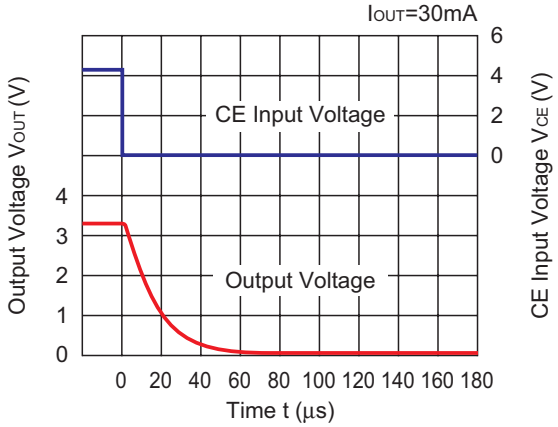
RP103x251D



RP103x331D



RP103x331D



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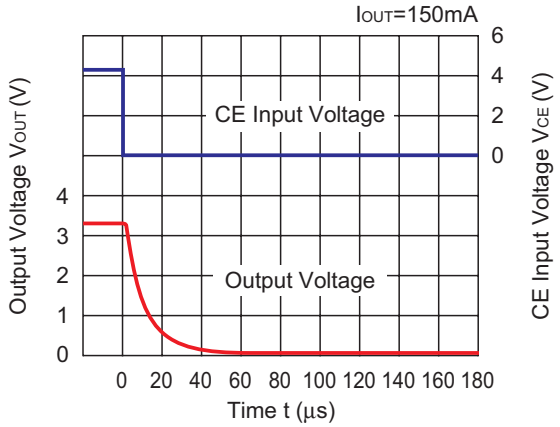
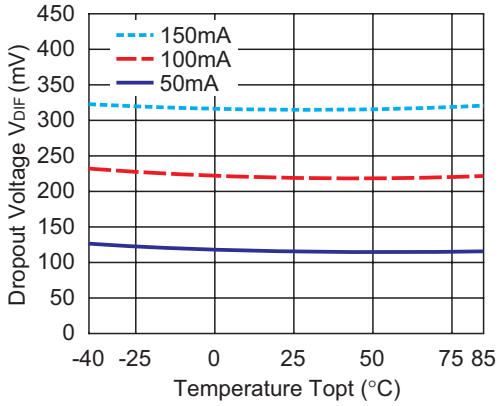
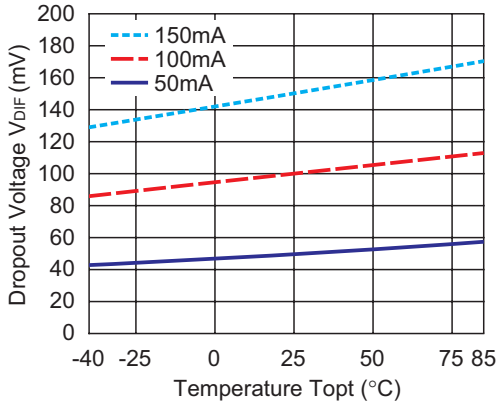


14) Dropout Voltage vs. Temperature (C1=0.47µF, C2=0.47µF)

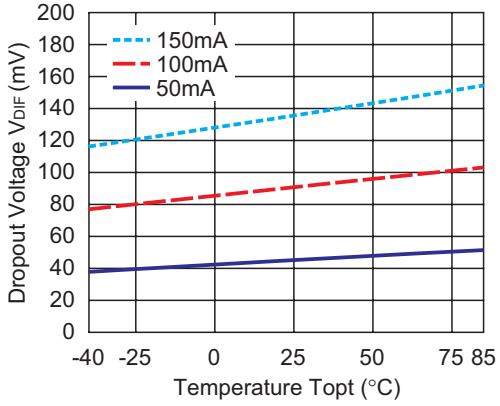
RP103x121x



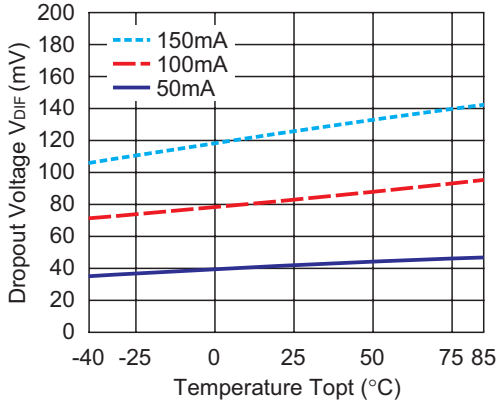
RP103x251x



RP103x301x



RP103x331x



ESR vs. Output Current

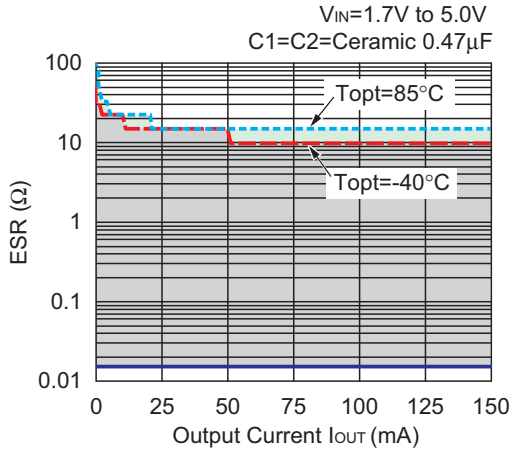
When using these ICs, consider the following points:

The relations between I_{OUT} (Output Current) and ESR of an output capacitor are shown below.
The conditions when the white noise level is under 40μV (Avg.) are marked as the hatched area in the graph.

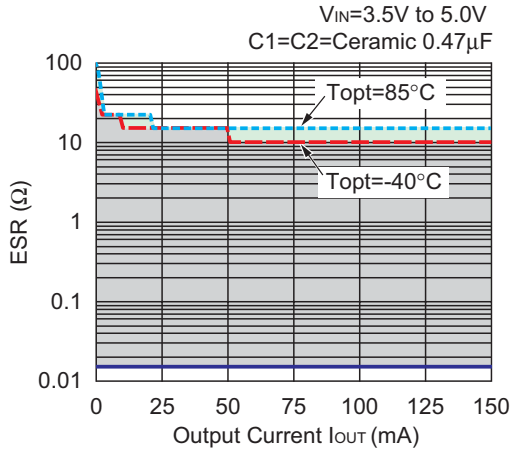
Measurement conditions

Frequency Band : 10Hz to 2MHz
Temperature : –40°C to 85°C

RP103x121x



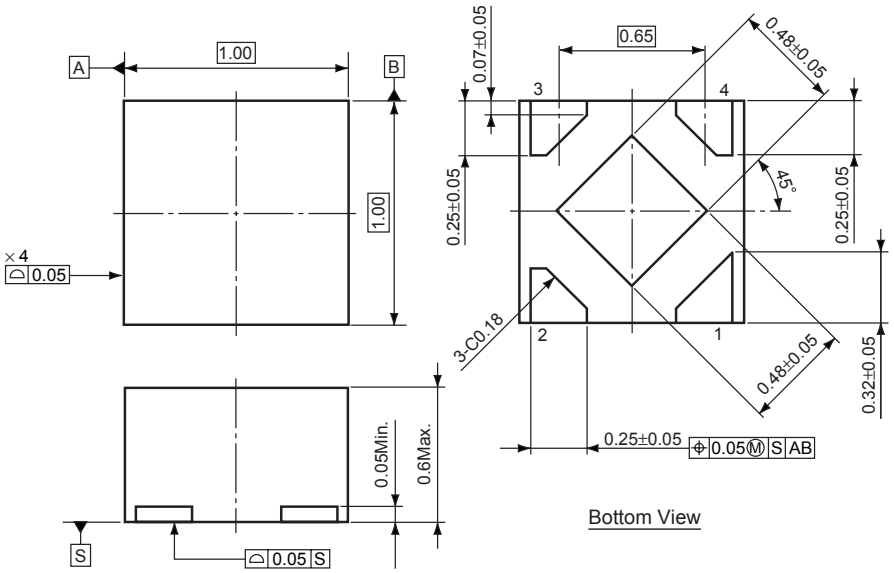
RP103x331x



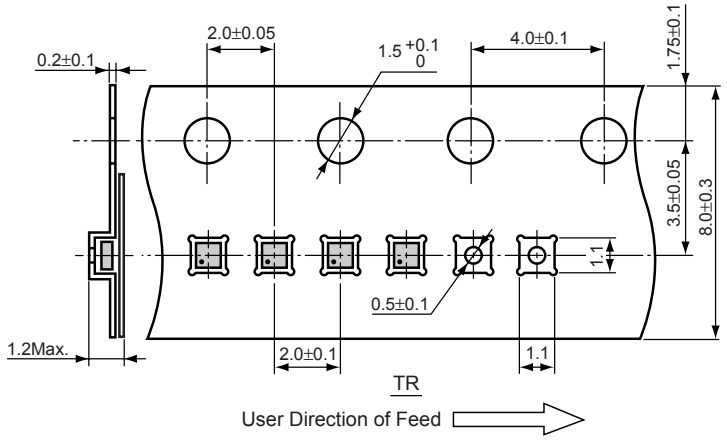
- **PLP1010-4**

Unit: mm

PACKAGE DIMENSIONS

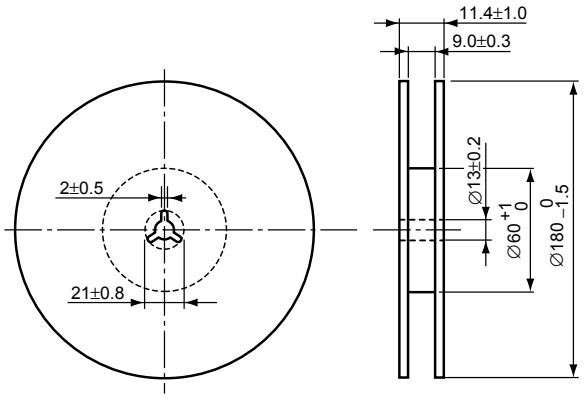


TAPING SPECIFICATION



TAPING REEL DIMENSIONS REUSE REEL (EIAJ-RRM-08Bc)

(1reel=10000pcs)



POWER DISSIPATION (PLP1010-4)

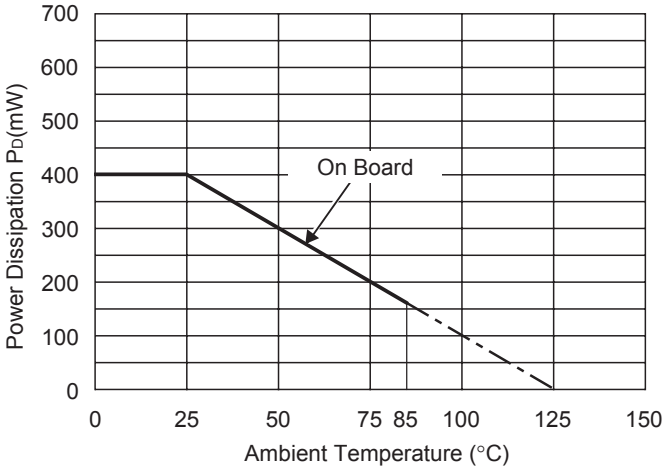
This specification is at mounted on board. Power Dissipation (P_D) depends on conditions of mounting on board. This specification is based on the measurement at the condition below:

Measurement Conditions

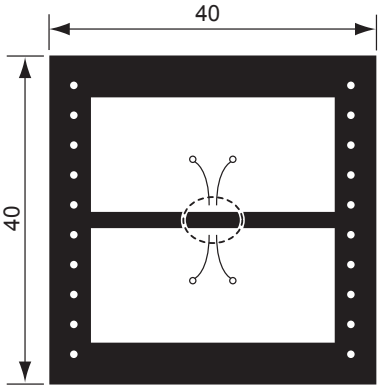
	Standard Land Pattern
Environment	Mounting on Board (Wind velocity=0m/s)
Board Material	Glass cloth epoxy plactic (Double sided)
Board Dimensions	40mm × 40mm × 1.6mm
Copper Ratio	Top side : Approx. 50% , Back side : Approx. 50%
Through-hole	ϕ0.54mm × 24pcs

Measurement Result (Topt=25°C,Tjmax=125°C)

	Standard Land Pattern
Power Dissipation	400mW
Thermal Resistance	θja=(125−25°C)/0.4W=250°C/W
Thermal Resistance	θjc=67°C/W



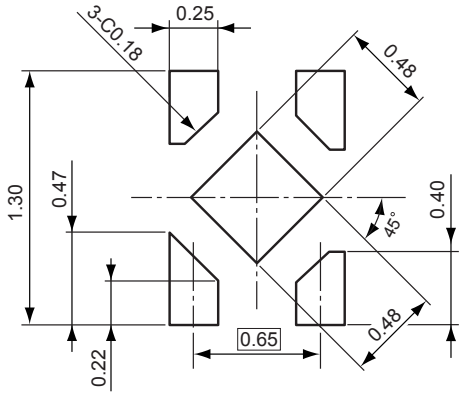
Power Dissipation



Measurement Board Pattern

IC Mount Area (Unit : mm)

RECOMMENDED LAND PATTERN

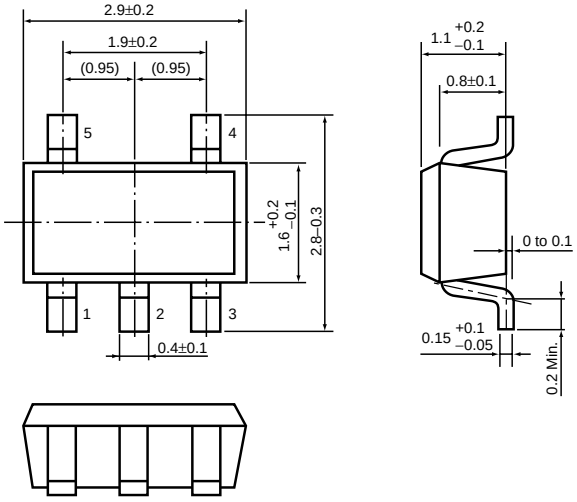


(Unit: mm)

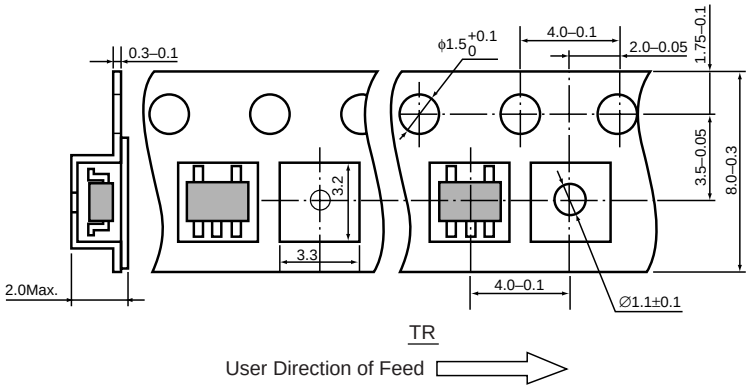
- **SOT-23-5 (SC-74A)**

Unit: mm

PACKAGE DIMENSIONS

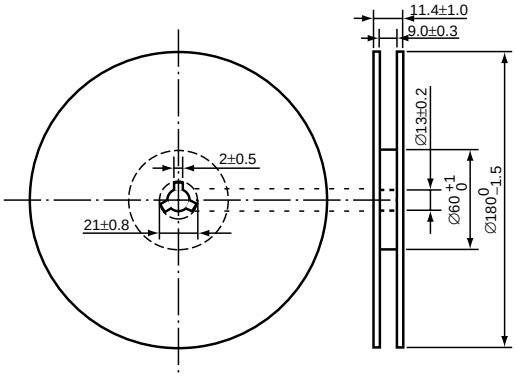


TAPING SPECIFICATION



TAPING REEL DIMENSIONS REUSE REEL (EIAJ-RRM-08Bc)

(1reel=3000pcs)



POWER DISSIPATION (SOT-23-5)

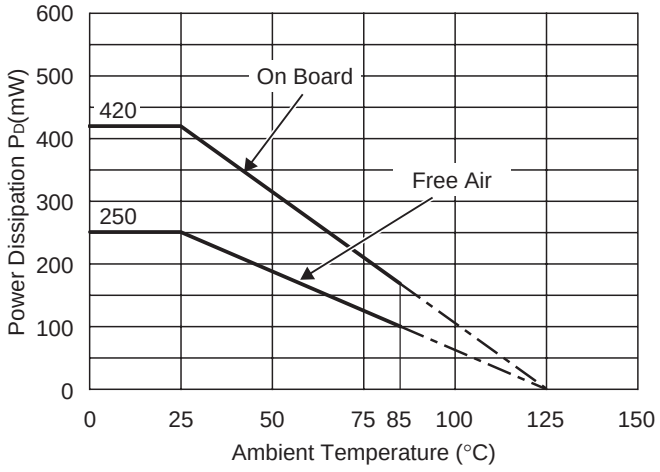
This specification is at mounted on board. Power Dissipation (P_D) depends on conditions of mounting on board. This specification is based on the measurement at the condition below:
(Power Dissipation (SOT-23-5) is substitution of SOT-23-6.)

Measurement Conditions

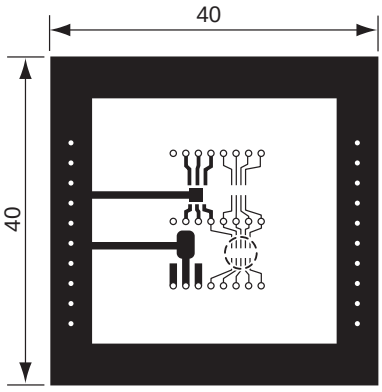
	Standard Land Pattern
Environment	Mounting on Board (Wind velocity=0m/s)
Board Material	Glass cloth epoxy plactic (Double sided)
Board Dimensions	40mm × 40mm × 1.6mm
Copper Ratio	Top side : Approx. 50% , Back side : Approx. 50%
Through-hole	ϕ0.5mm × 44pcs

Measurement Result (Topt=25°C,Tjmax=125°C)

	Standard Land Pattern	Free Air
Power Dissipation	420mW	250mW
Thermal Resistance	θja=(125−25°C)/0.42W=263°C/W	400°C/W



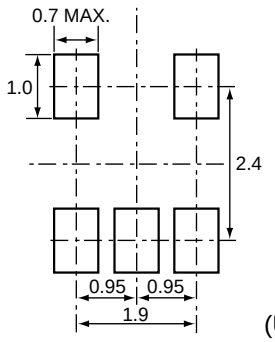
Power Dissipation



Measurement Board Pattern

IC Mount Area Unit : mm

RECOMMENDED LAND PATTERN

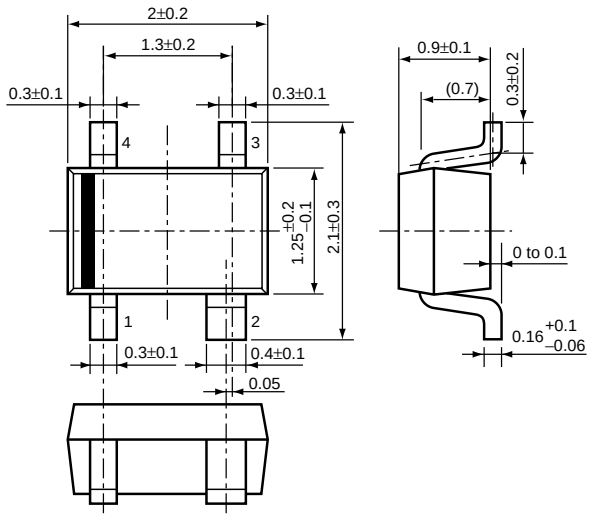


(Unit: mm)

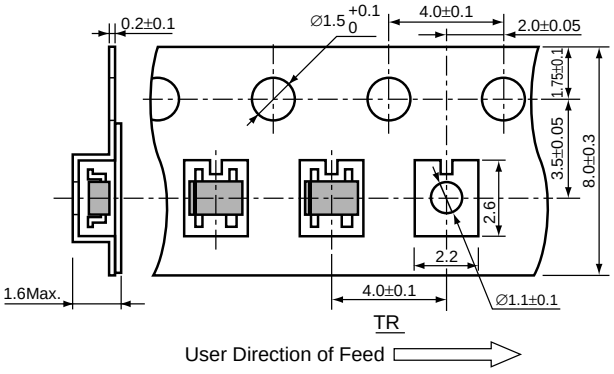
- **SC-82AB**

Unit: mm

PACKAGE DIMENSIONS

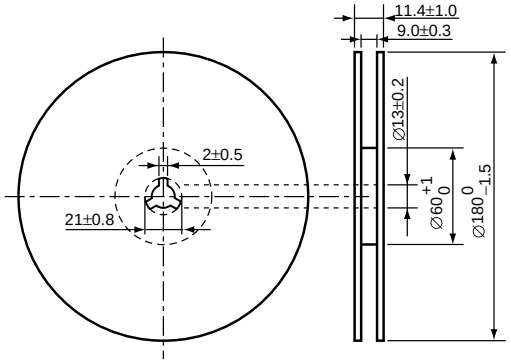


TAPING SPECIFICATION



TAPING REEL DIMENSIONS

(1reel=3000pcs)



POWER DISSIPATION (SC-82AB)

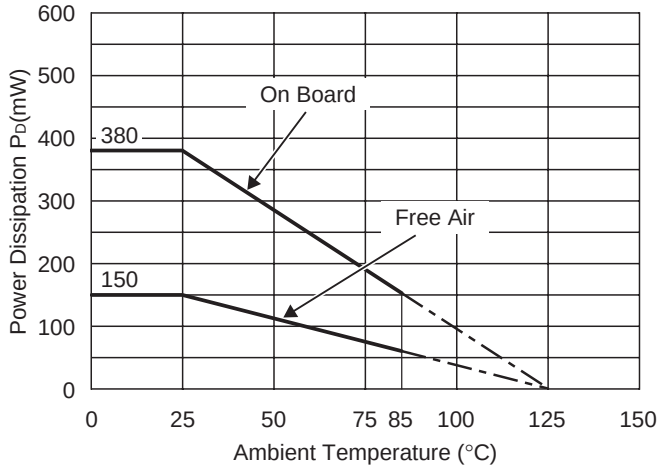
This specification is at mounted on board. Power Dissipation (P_D) depends on conditions of mounting on board. This specification is based on the measurement at the condition below:

Measurement Conditions

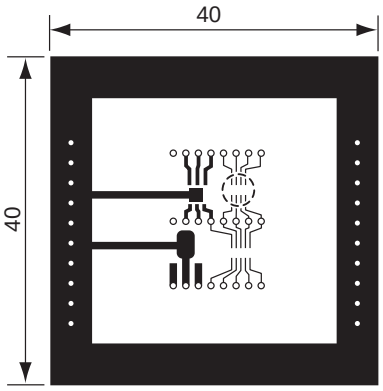
	Standard Land Pattern
Environment	Mounting on Board (Wind velocity=0m/s)
Board Material	Glass cloth epoxy plactic (Double sided)
Board Dimensions	40mm × 40mm × 1.6mm
Copper Ratio	Top side : Approx. 50% , Back side : Approx. 50%
Through-hole	ϕ0.5mm × 44pcs

Measurement Result (Topt=25°C,Tjmax=125°C)

	Standard Land Pattern	Free Air
Power Dissipation	380mW	150mW
Thermal Resistance	θja=(125−25°C)/0.38W=263°C/W	667°C/W



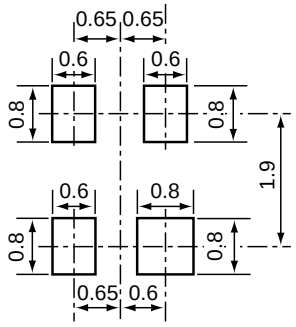
Power Dissipation



Measurement Board Pattern

IC Mount Area (Unit : mm)

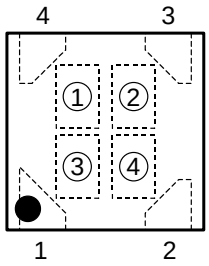
RECOMMENDED LAND PATTERN



(Unit: mm)

RP103K SERIES MARK SPECIFICATION

- **PLP1010-4**



①, ② : Product Code (Refer to Part Number vs. Product Code)

③, ④ : Lot Number

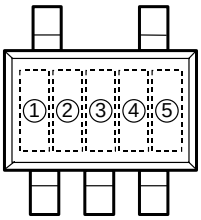
- **Part Number vs. Product Code**

Part Number	Product Code	
	①	②
RP103K121B	7	A
RP103K131B	7	B
RP103K151B	7	C
RP103K181B	7	D
RP103K181B5	7	E
RP103K191B	7	F
RP103K201B	7	G
RP103K251B	7	H
RP103K261B	7	J
RP103K271B	7	K
RP103K281B	7	L
RP103K281B5	7	M
RP103K291B	7	N
RP103K301B	7	P
RP103K311B	7	Q
RP103K331B	7	R
RP103K231B	7	S

Part Number	Product Code	
	①	②
RP103K121D	8	A
RP103K131D	8	B
RP103K151D	8	C
RP103K181D	8	D
RP103K181D5	8	E
RP103K191D	8	F
RP103K201D	8	G
RP103K251D	8	H
RP103K261D	8	J
RP103K271D	8	K
RP103K281D	8	L
RP103K281D5	8	M
RP103K291D	8	N
RP103K301D	8	P
RP103K311D	8	Q
RP103K331D	8	R
RP103K231D	8	S

RP103N SERIES MARK SPECIFICATION

- **SOT-23-5**



①, ②, ③ : Product Code (Refer to Part Number vs. Product Code)

④, ⑤ : Lot Number

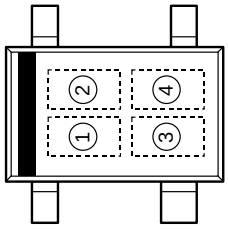
- **Part Number vs. Product Code**

Part Number	Product Code		
	①	②	③
RP103N121B	8	0	A
RP103N131B	8	0	B
RP103N151B	8	0	C
RP103N181B	8	0	D
RP103N181B5	8	0	E
RP103N191B	8	0	F
RP103N201B	8	0	G
RP103N251B	8	0	H
RP103N261B	8	0	J
RP103N271B	8	0	K
RP103N281B	8	0	L
RP103N281B5	8	0	M
RP103N291B	8	0	N
RP103N301B	8	0	P
RP103N311B	8	0	Q
RP103N331B	8	0	R
RP103N231B	8	0	S

Part Number	Product Code		
	①	②	③
RP103N121D	8	1	A
RP103N131D	8	1	B
RP103N151D	8	1	C
RP103N181D	8	1	D
RP103N181D5	8	1	E
RP103N191D	8	1	F
RP103N201D	8	1	G
RP103N251D	8	1	H
RP103N261D	8	1	J
RP103N271D	8	1	K
RP103N281D	8	1	L
RP103N281D5	8	1	M
RP103N291D	8	1	N
RP103N301D	8	1	P
RP103N311D	8	1	Q
RP103N331D	8	1	R
RP103N231D	8	1	S

RP103Q SERIES MARK SPECIFICATION

- **SC-82AB**



①, ② : Product Code (Refer to Part Number vs. Product Code)

③, ④ : Lot Number

- **Part Number vs. Product Code**

Part Number	Product Code	
	①	②
RP103Q121B	G	0
RP103Q131B	G	1
RP103Q151B	G	2
RP103Q181B	G	3
RP103Q181B5	G	4
RP103Q191B	G	5
RP103Q201B	G	6
RP103Q251B	G	7
RP103Q261B	G	8
RP103Q271B	G	9
RP103Q281B	H	0
RP103Q281B5	H	1
RP103Q291B	H	2
RP103Q301B	H	3
RP103Q311B	H	4
RP103Q331B	H	5
RP103Q231B	H	6

Part Number	Product Code	
	①	②
RP103Q121D	J	0
RP103Q131D	J	1
RP103Q151D	J	2
RP103Q181D	J	3
RP103Q181D5	J	4
RP103Q191D	J	5
RP103Q201D	J	6
RP103Q251D	J	7
RP103Q261D	J	8
RP103Q271D	J	9
RP103Q281D	K	0
RP103Q281D5	K	1
RP103Q291D	K	2
RP103Q301D	K	3
RP103Q311D	K	4
RP103Q331D	K	5
RP103Q231D	K	6